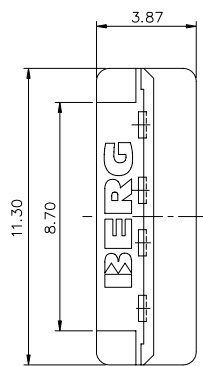
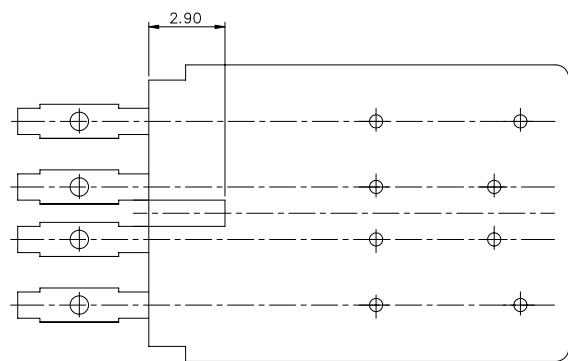
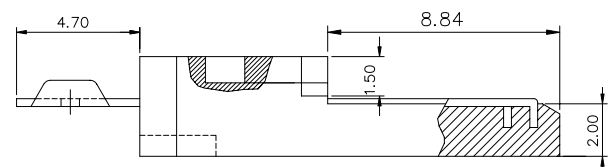
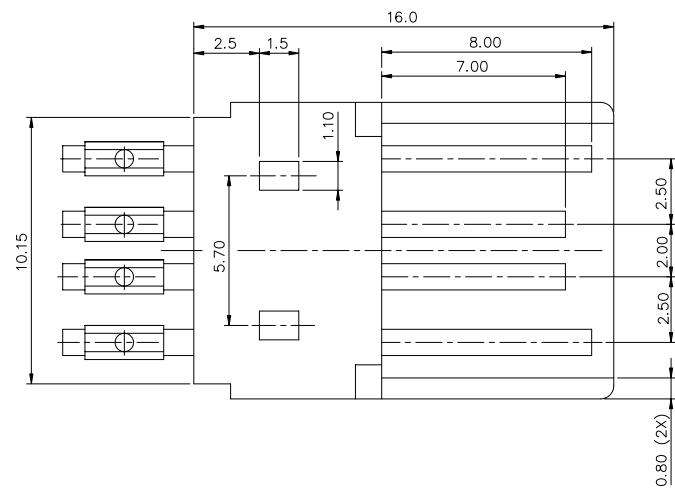


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PRODUCT NO.
73767



NOTES:

- 1.MATERIAL:
CONTACT: COPPER ALLOY
INSULATOR:UL-94V-0 RATE THERMOPLASTIC
- 2.FLASH ARROUND CONTACT < 0.08mm WHICH COULD NOT OVER THE CONTACT PLAN.
- 3.NO MORE THAN 20% OF REGROUND PBT MATERIAL COULD BE MIXED.
- 4.LOGO DIM 4.8 mm WIDE.
- 5.P/N 73767- * 0 *
COLOR:
0-WHITE
PLATING CODE:
SEE CONTACT AREA:
CONTACT AREA:
1.27um/50u" MIN. NICKEL UNDERPLATE ON BOTH SIDES GLOD FLSH OVER 0.76um/30u" MIN GTX REQ'D ON CONTACT SIDE OF TERMINAL ONLY FOR-X01.
1.27um/50u" MIN. NICKEL UNDERPLATE BOTH SIDES. GOLD PLATED 15u",MIN. REQ'D ON CONTACT SIDE OF TERMINAL ONLY. FOR-X02
1.27um/50u" MIN. NICKEL UNDERPLATE BOTH SIDES. GOLD PLATED 30u",MIN. REQ'D ON CONTACT SIDE OF TERMINAL ONLY. FOR-X03
1.27um/50u" MIN. NICKEL UNDERPLATE BOTH SIDES. GOLD FLASH, REQ'D ON CONTACT SIDE OF TERMINAL ONLY. FOR-X04
SOLDER AREA:
1.27um/50u" MIN. NICKEL UNDERPLATE, BOTH SIDES. 2.54um/100u" MIN. ALLOY 90/10 TIN/LEAD. BOTH SIDES.
6. P/N'S WITH SUFFIX "LF" ARE LEAD FREE P/N'S
7. PACKING STANDARD GS-14-920 WILL BE APPLIED FOR LEAD FREE P/N'S
8. FOR LEAD FREE P/N, THE PRODUCT MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY REGULATION AS DESCRIBED IN GS-22-008

mat'l code					tolerance unless otherwise specified		CUSTOMER COPY		A FCI www.fciconnect.com		
rev.	ecn no.	dr	date		linear	.0 ± 0.30		projection	title USB A TYPE PLUG KIT TERMINAL MOLDING		
A	T70418	P P	10/6/97			.00 ± 0.20					
B	N05-0095	P H	03/29/05			.000± 0.10					
					angles	± 3°					
					dr	PETER PAM	9/12/97		unit	product family USB	
					engr	R Y LIU	9/12/97		mm	size	
					chr	R Y LIU	9/12/97		scale	dwg no.	
					appd	JENN TSAO	9/12/97			A3	73767
sheet	revision	B									
index	sheet										

PDM- Rev:B

STATUS Released

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